

Quantum Dots: formation

ECE 598XL

Fall 2009

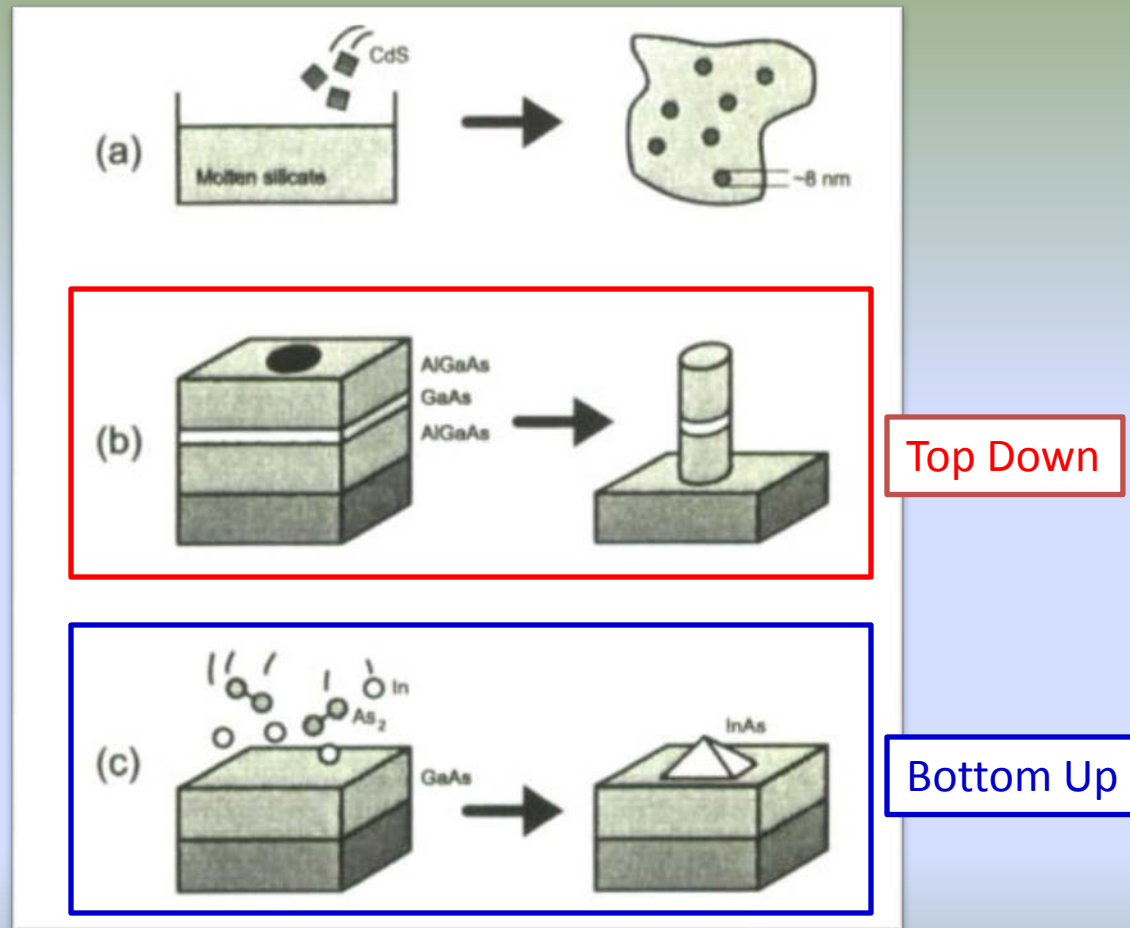
Outline

- Introduction
- Self-organized QDs
 - Critical thickness
 - S-K growth mode
- Patterned QDs
 - Lateral positioning
 - Multistack ordering
- QDs in QWs
 - Case study: InGaN QDs in InGaN QW
- Anti dots

QD Based Device Applications

- QD infrared photodetectors (interband and intraband optical transitions)
- QD lasers and LEDs
 - Edge emitters
 - VCSELs
 - Photonic crystals
- QD solar cells
- Single QD as building blocks for
 - Quantum information processing
 - single electron devices
- Dislocation filter for metamorphic growth

Methods of Nanostructure Formation



D. Bimberg, M. Grundmann, N. Ledentsov, "Quantum Dot Heterostructures"

Spontaneously Formed Nanostructures

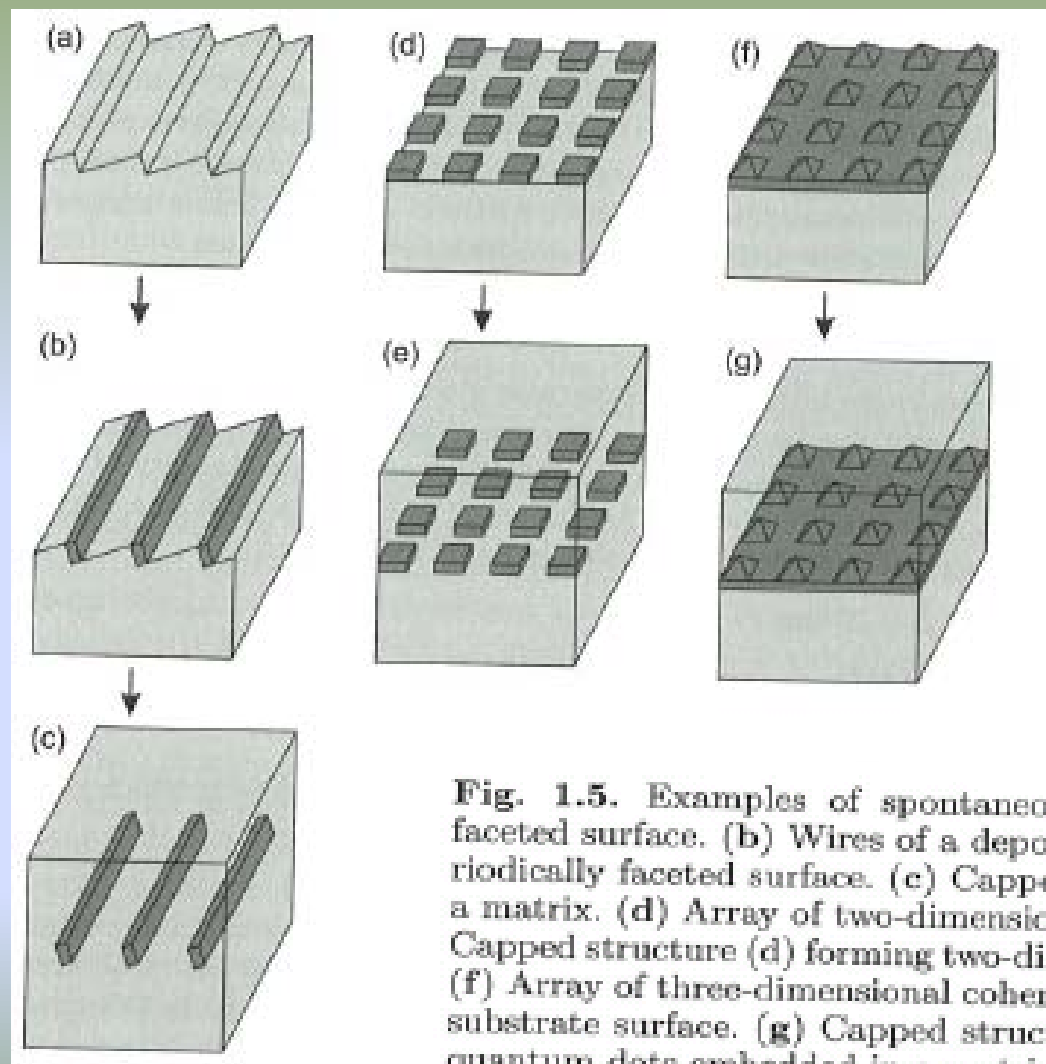


Fig. 1.5. Examples of spontaneously formed nanostructures. (a) Periodically faceted surface. (b) Wires of a deposited material formed in the grooves of the periodically faceted surface. (c) Capped structure (b) forming quantum wires within a matrix. (d) Array of two-dimensional islands in submonolayer heteroepitaxy. (e) Capped structure (d) forming two-dimensional quantum dots embedded in a matrix. (f) Array of three-dimensional coherently strained islands over a wetting layer on a substrate surface. (g) Capped structure (f) forming an array of three-dimensional quantum dots embedded in a matrix

QD Formation Methods

- **Self-organized QDs**

- Stranski-krastanov growth:
 - Lattice mismatch
 - Strain
- Growth methods:
 - MOCVD
 - MBE

- **Patterned QDs**

- Lithography
- Etching
- Growth

- **Colloidal QDs**

- Reaction T, t
- Core-shell
- Biological tag

Critical Layer Thickness

- **Pseudomorphic**: for thin layer where the overlayer is coherently strained (overlayer adopt lattice constant of the substrate).
- **Dislocation formation**: for thick layers where the overlayer is relaxed (adopt its original lattice constant) through dislocation formation.
- **Critical layer thickness**: transition between the above two regions
 - Function of mismatch strain, etc.
 - Matthews-Blakeslee model (1970s)
 - Ge on Si (4%): 3- 4 ML
 - InAs on GaAs (7.2%): 1.7 ML
 - InAs on porous GaAs: 4.2 ML

$$E_{strain} = \lambda \left(\frac{\Delta a}{a} \right)^2 A t$$

λ = elastic modulus

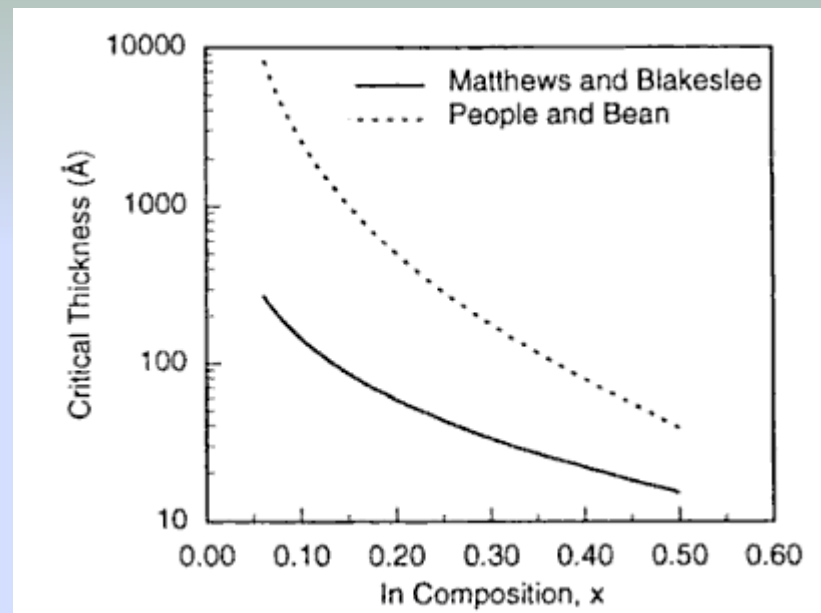
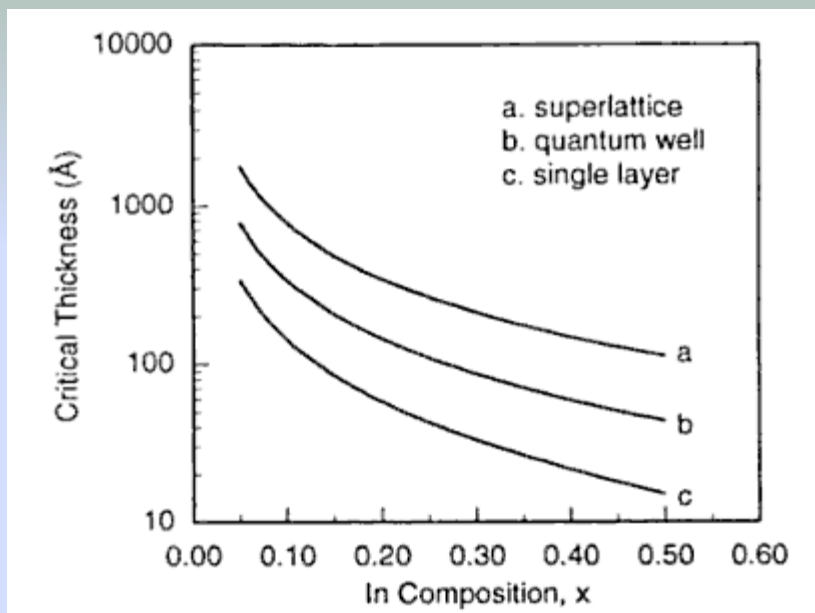
Δa = forced change in lattice constant

a = "free" lattice constant

A = area

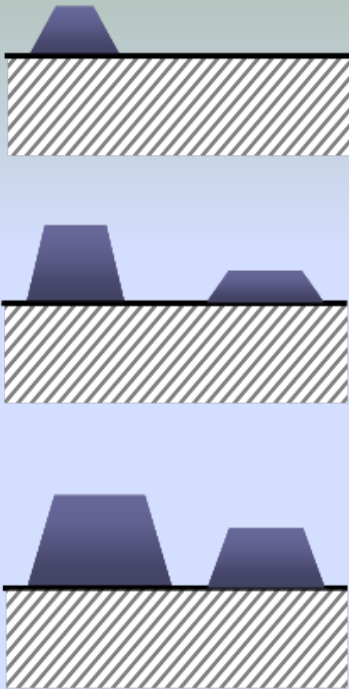
t = thickness

Critical Layer Thickness

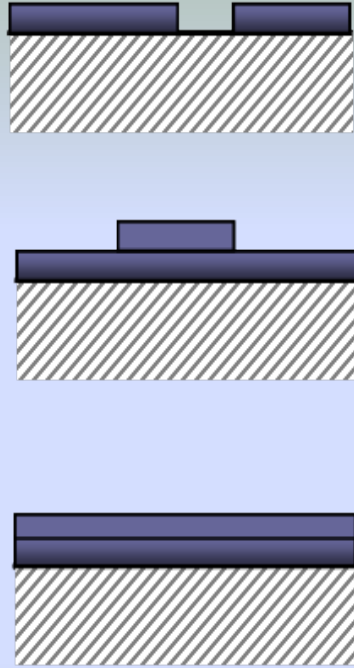


Three Modes of Epitaxial Growth

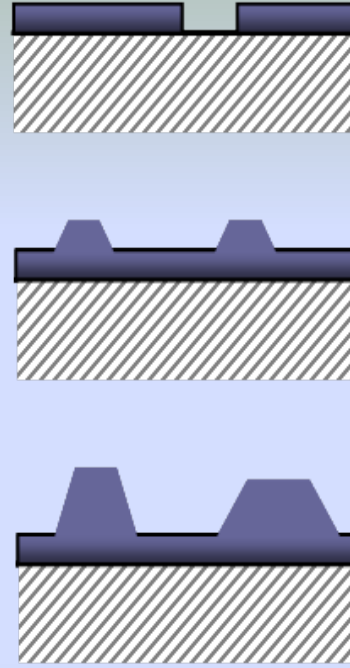
**Volmer-Weber
(islands)**



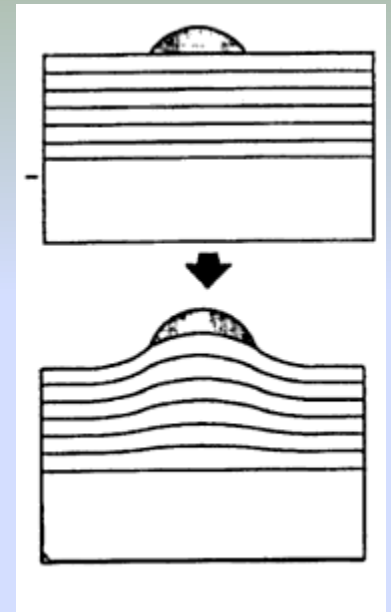
**Frank-van der Merwe
(layer-by-layer)**



**Stranski-Krastanov
(layer-plus-island)**



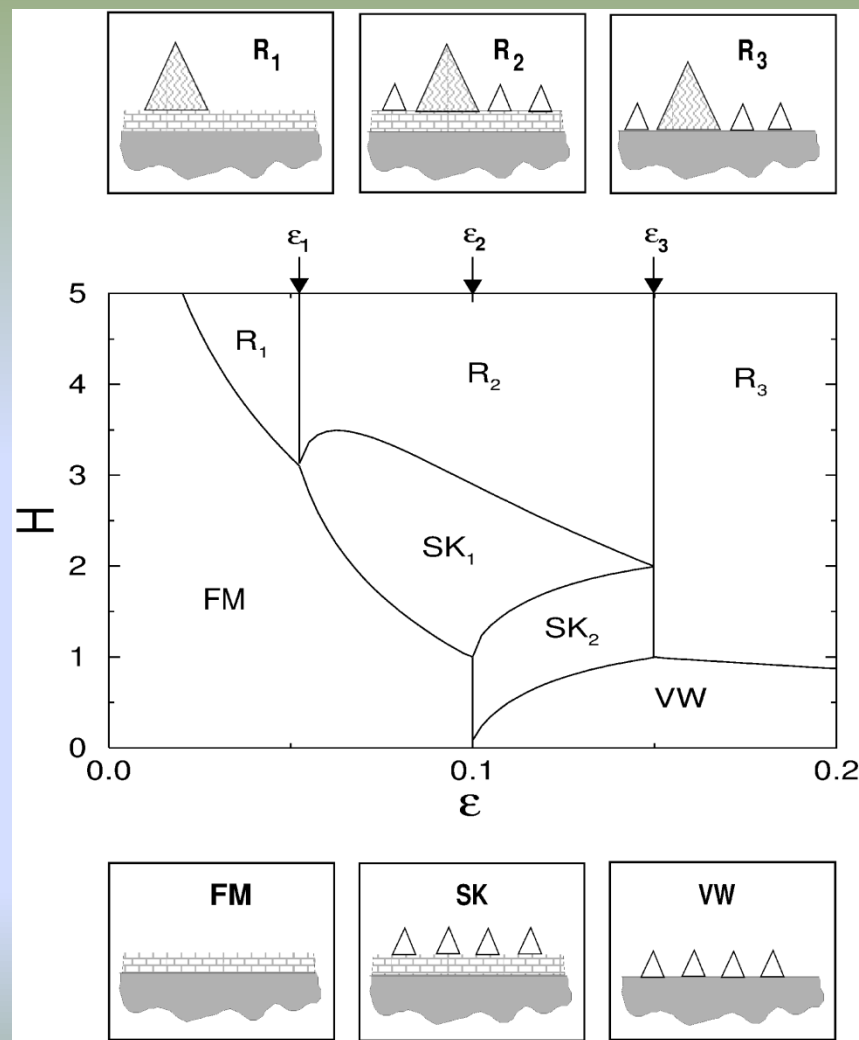
**Stranski-Krastanov
(layer-plus-island)**



strain sharing

Phase Diagram

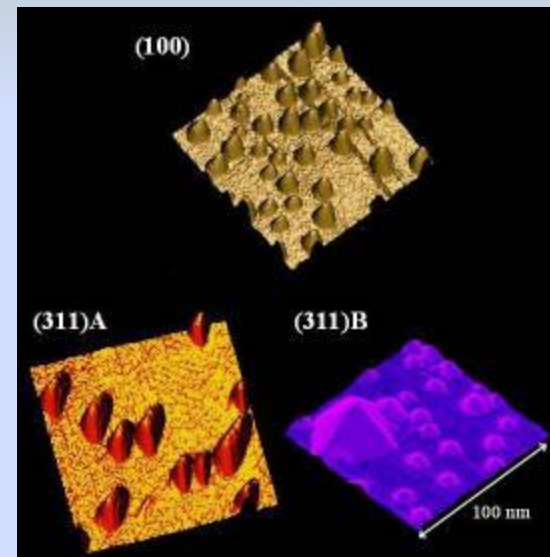
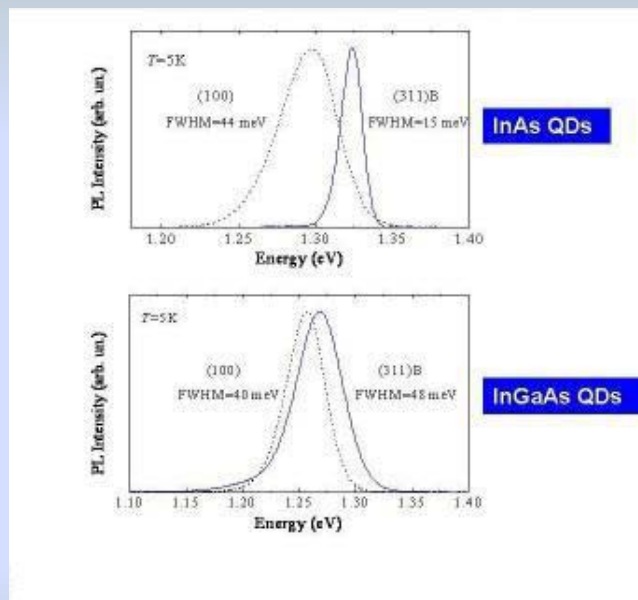
coverage H (ML) vs misfit strain ϵ



QDs – shape, size, size distribution

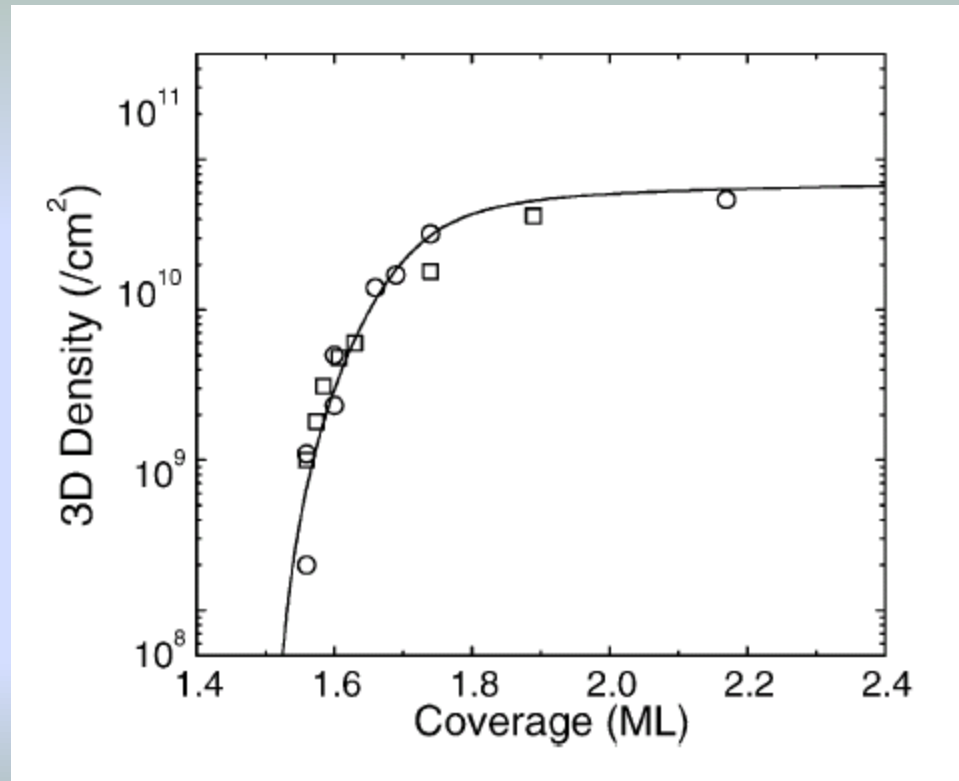
- Substrate orientation dependence

STM of InAs/GaAs QDs grown by MBE on (100), (311)A and (311)B GaAs substrates.



Coverage vs QD Density

- Density of 3D islands vs InAs coverage

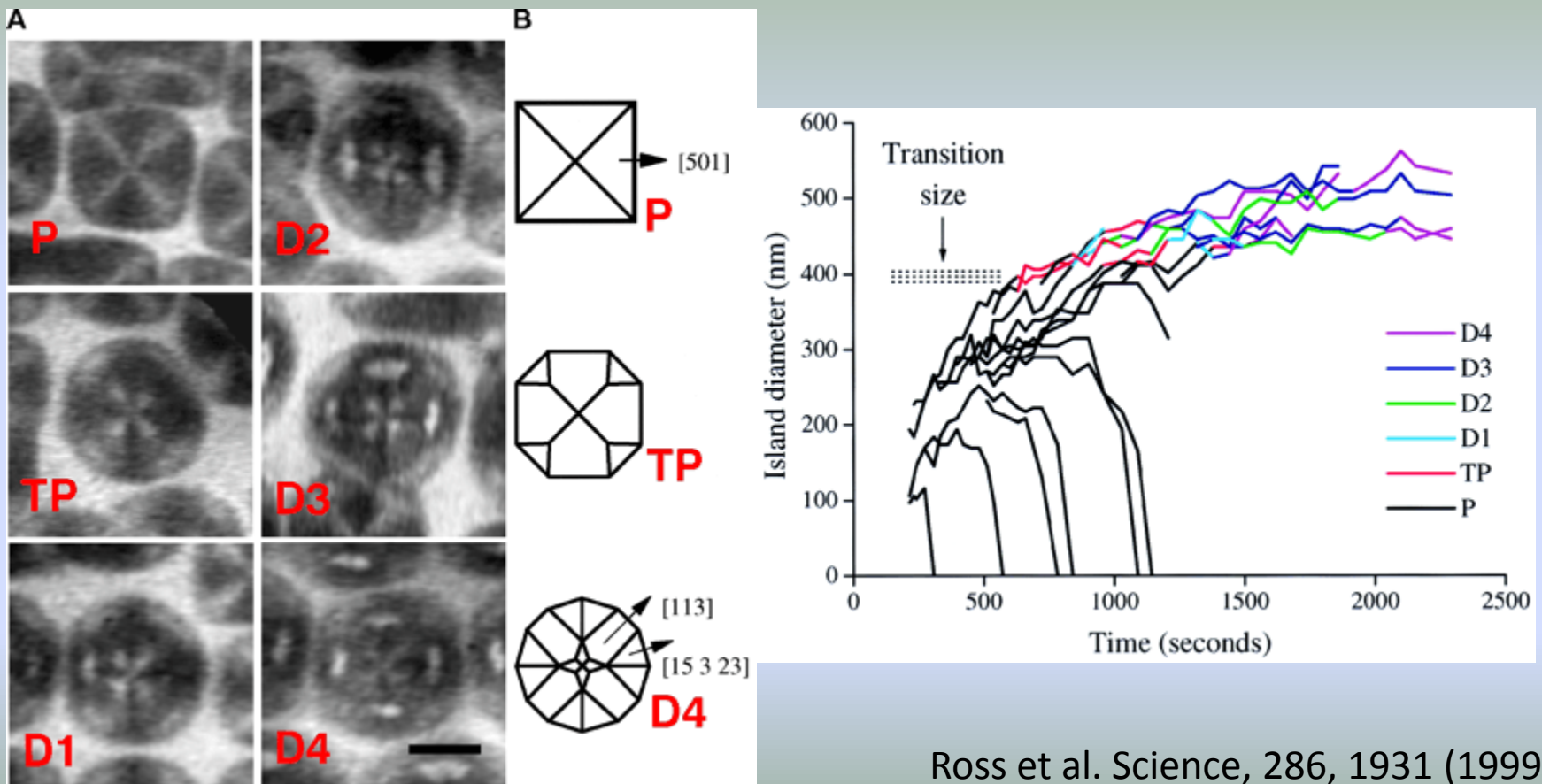


QDs – shape, size, size distribution

- Ge QDs/Si(100):
 - Competition between surface energy and strain relaxation in the island bulk
 - Pyramids (high aspect ratio, square base with {105} facets): more surface energy but relaxes more strain
 - Domes (low aspect ratio, multi-faceted):
 - Change from pyramids to domes w size
- InAs/GaAs
 - Pyramid: bounded by four steep {137} facets

QDs – shape, size, size distribution

- Growth conditions, size and composition dependence



Ross et al. Science, 286, 1931 (1999)

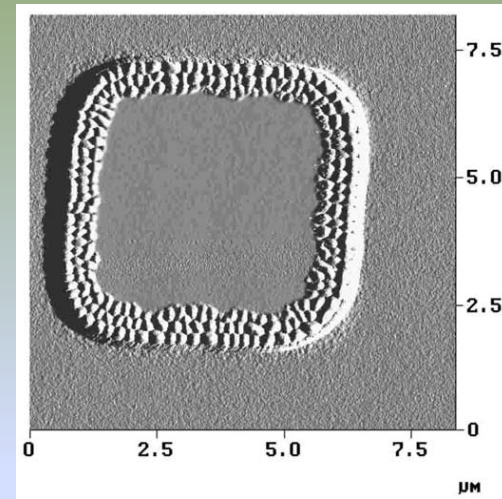
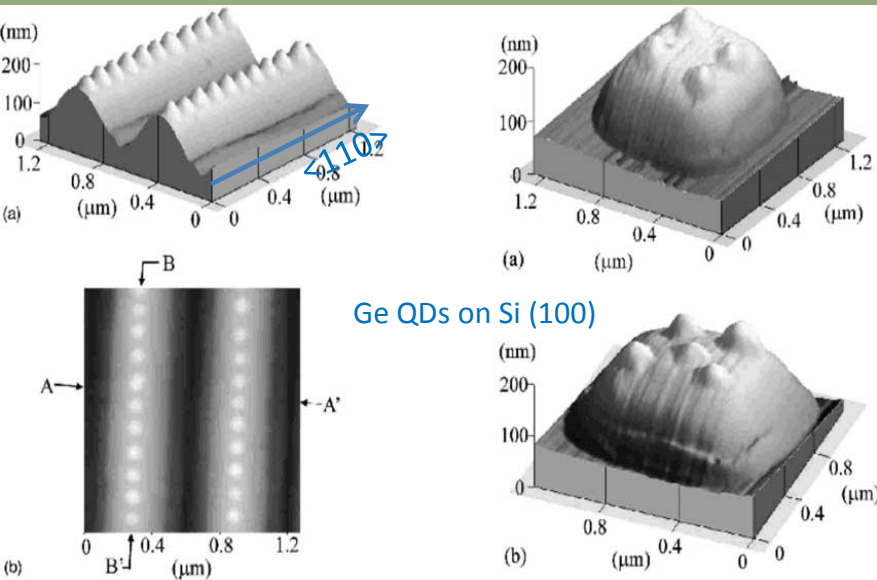
Criteria for QD Growth

- Size controllability: size and uniformity
- Site controllability: positioning and density
- Vertical stacking and ordering

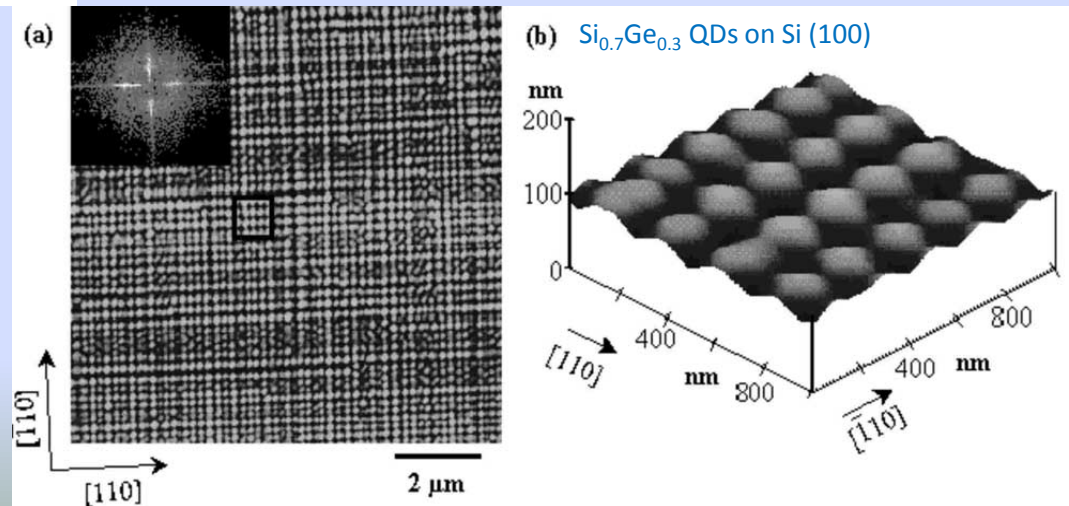
Lateral Positioning: patterned QDs

- Site control using preferential nucleation sites on a substrate
 - ex situ Lithography defined surface morphology
 - Maskless – self strain management
 - Raised stripes and squares
 - Pits/holes (ebeam, nanoporous Al_2O_3 template, diblock copolymer nanopatterning, etc.)
 - Masked (growth inhibition) selective area growth
 - Oxide
 - metal
 - Surface steps and bunches
 - Intentional formation of dislocations

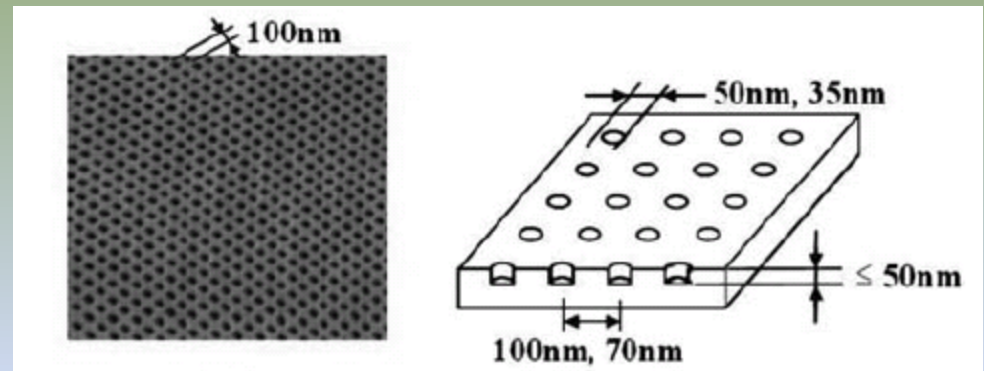
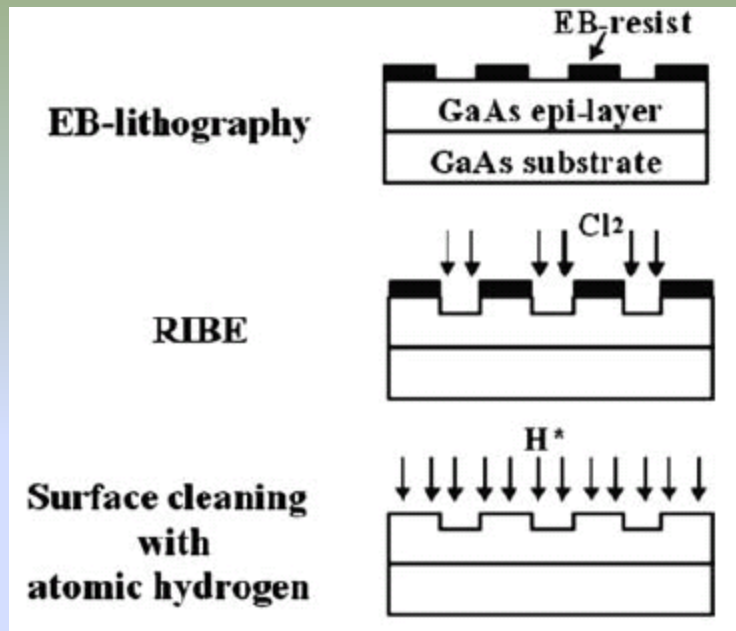
Lateral Positioning: patterned QDs



Strain Management



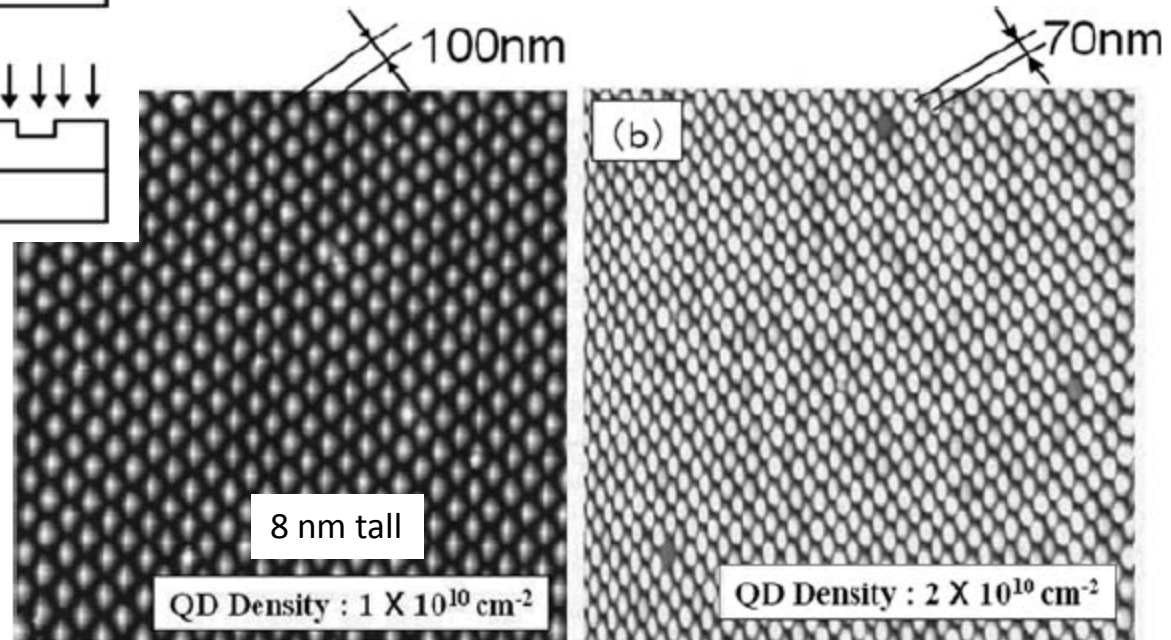
Patterned substrate with nano hole arrays



Localized modification of surface strain after in-filling

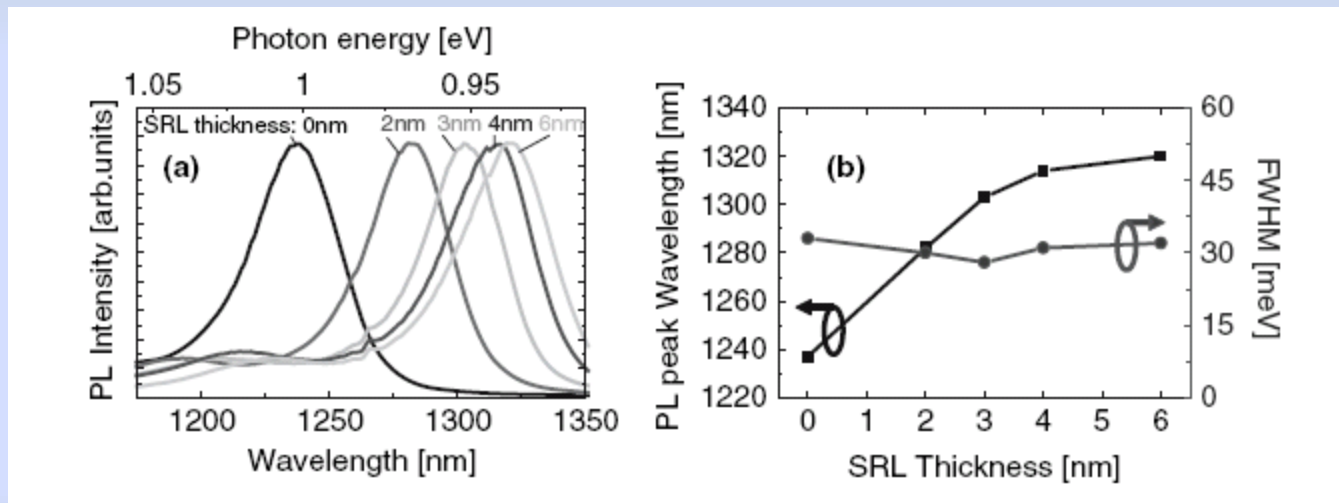
InGaAs QD nucleation is achieved by reducing T from 400 to 300 °C

100% occupancy!

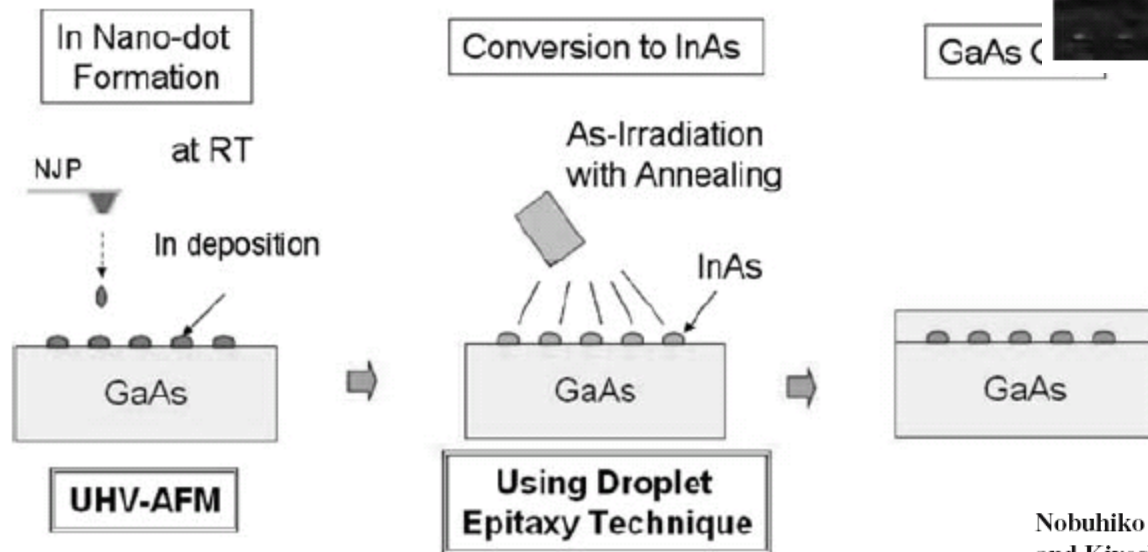
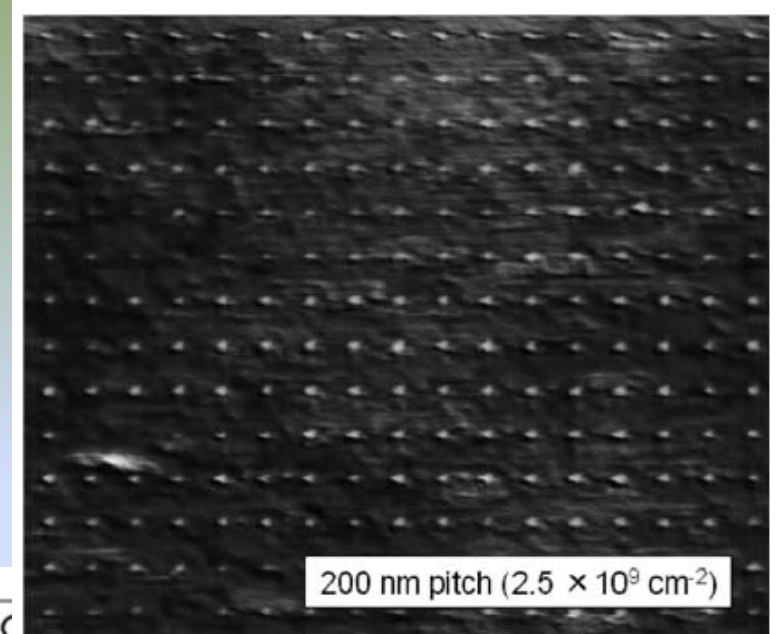
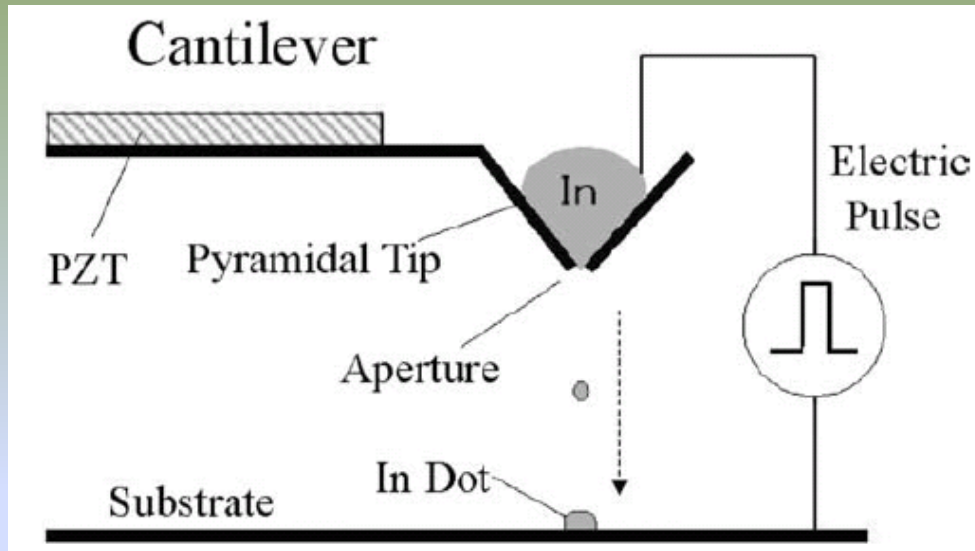


Site-controlled InAs QDs

- PL wavelength tuning using strain reducing layer $\text{In}_{0.2}\text{Ga}_{0.8}\text{As}$ (0 – 6 nm) on the InAs QDs



InAs QDs by Nano Jet Probe Patterning



Linear alignment of GaN QDs on vicinal AlN/SiC substrate by controlled nucleation on steps

- Vicinal SiC substrate preparation
- Stepped AlN layer
 - Height and width of AlN step – growth condition dependent

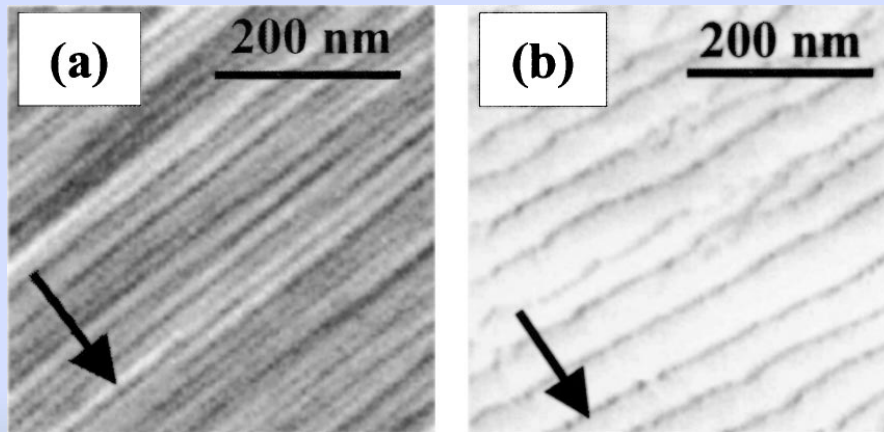


FIG. 1. AFM images of ~a! a 4H-SiC~0001! vicinal surface after HCl/H₂ etching and ~b! a ~50 nm AlN layer grown on a 4H-SiC~0001! vicinal surface. The arrow on the images indicates the [11-20] direction.

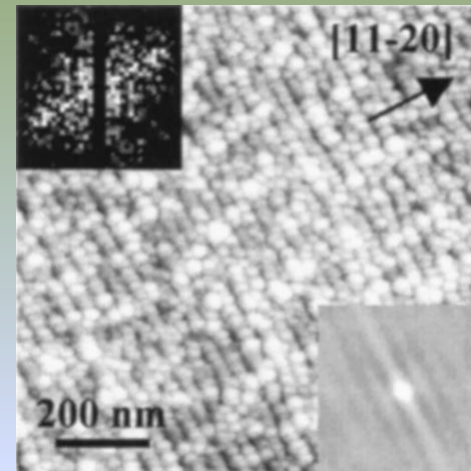


FIG. 4. AFM image of GaN quantum dots grown on a vicinal AlN~0001! surface. The upper inset gives the details of the 2D-FFT spectrum and the lower inset gives details of the center of the autocorrelation picture.

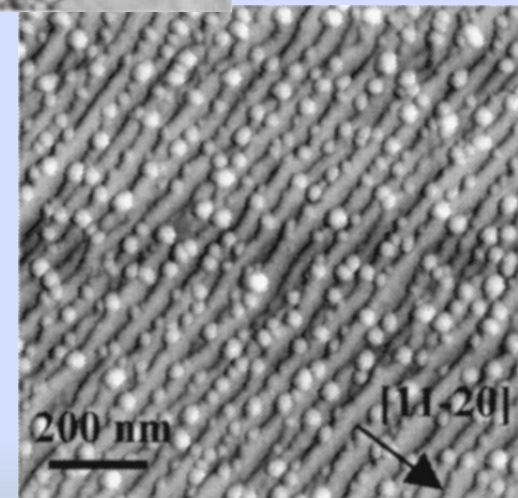
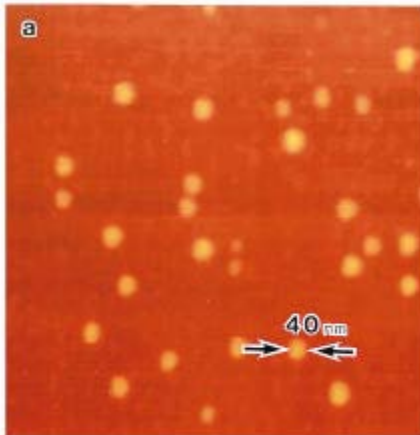


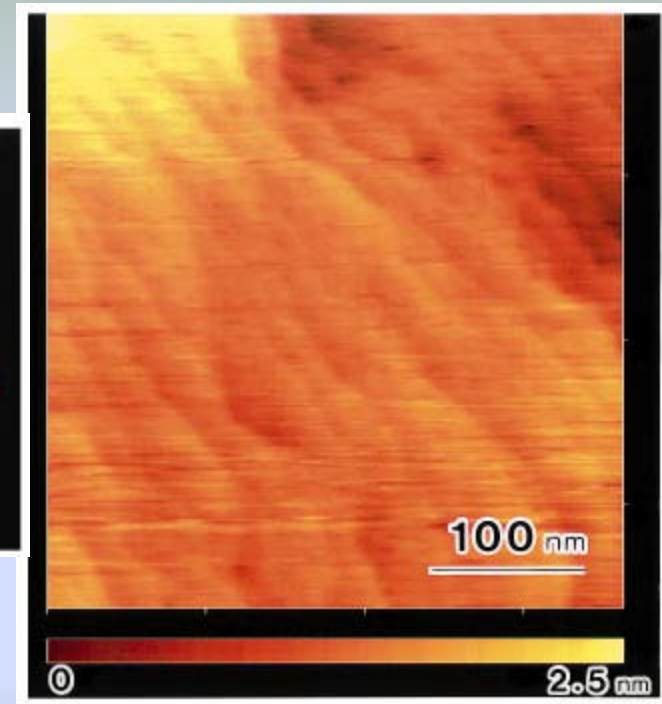
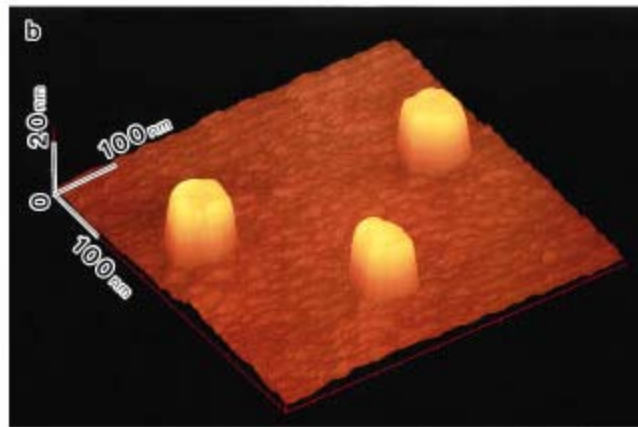
FIG. 2. AFM image showing the preferential alignment of GaN QDs along the AlN bunched steps.

QDs growth using anti-surfactant

- Anti-surfactant: to promote 3D growth
 - Tetraethylsilane $\text{Si}(\text{C}_2\text{H}_5)_4$ (TESi)
 - Modifies surface energy



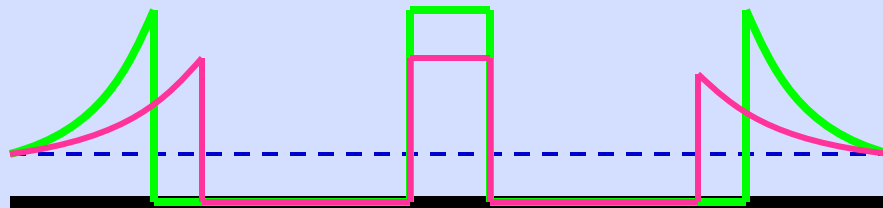
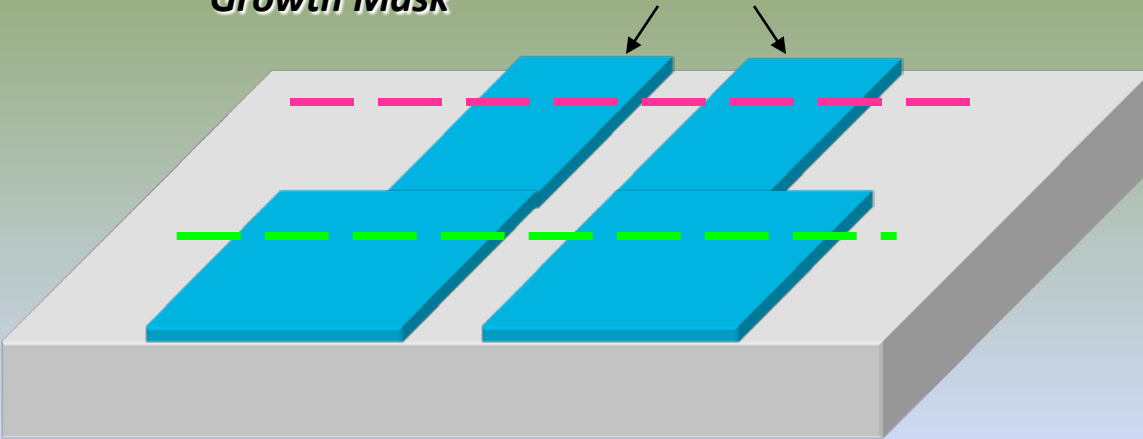
w TESI, QDs 3×10^9 density



w/o TESI. No QDs

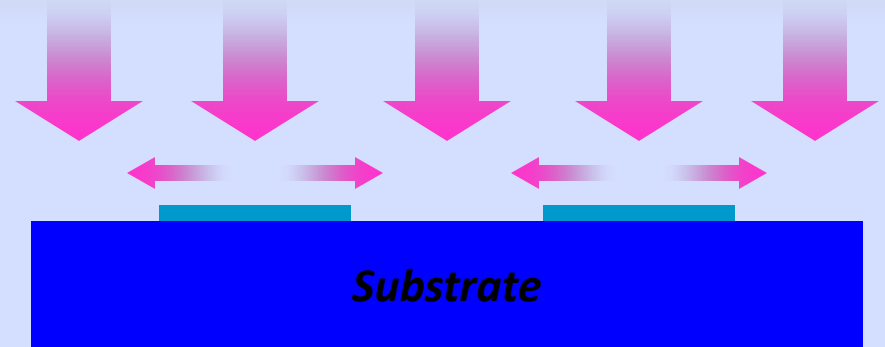
Selective Area Epitaxy Process Overview

*Dual Stripe Pattern
Growth Mask*



Epitaxial Growth Rate Enhancement

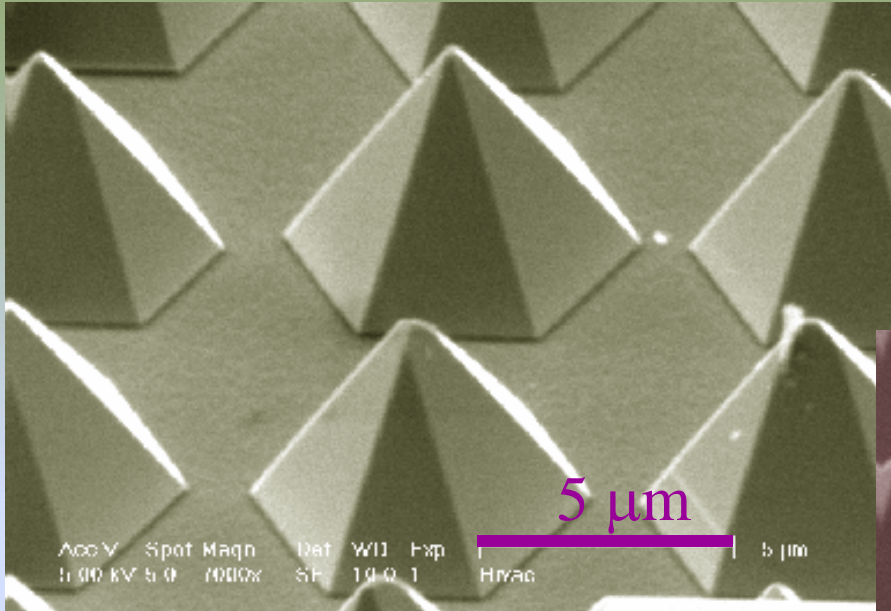
Source Material



Substrate

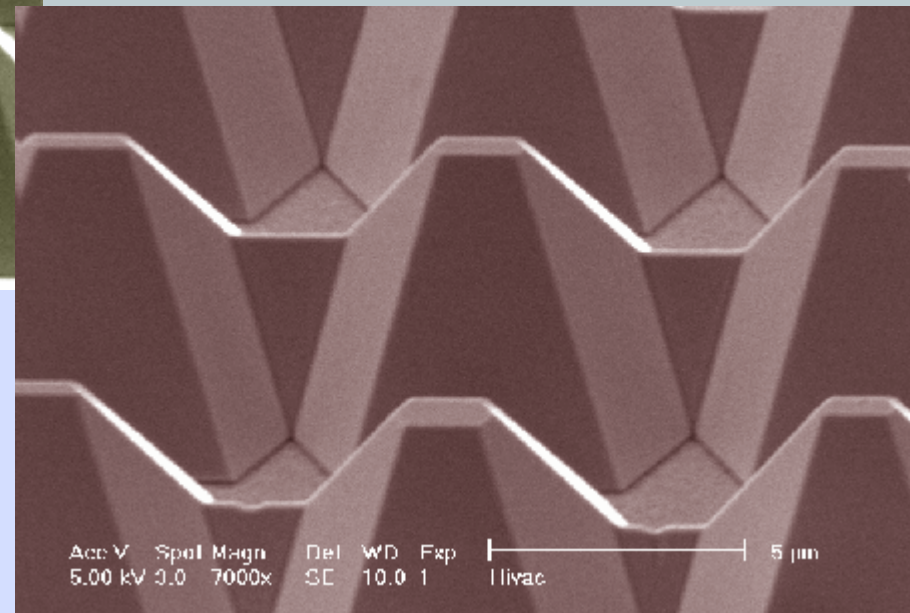
*Growth occurs at exposed
crystal surface only*

Selective area growth and lateral overgrowth



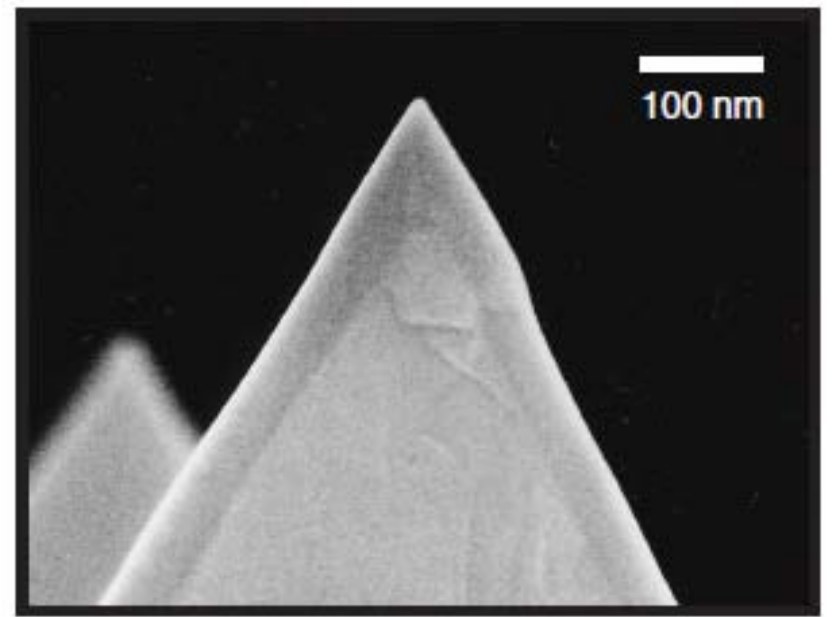
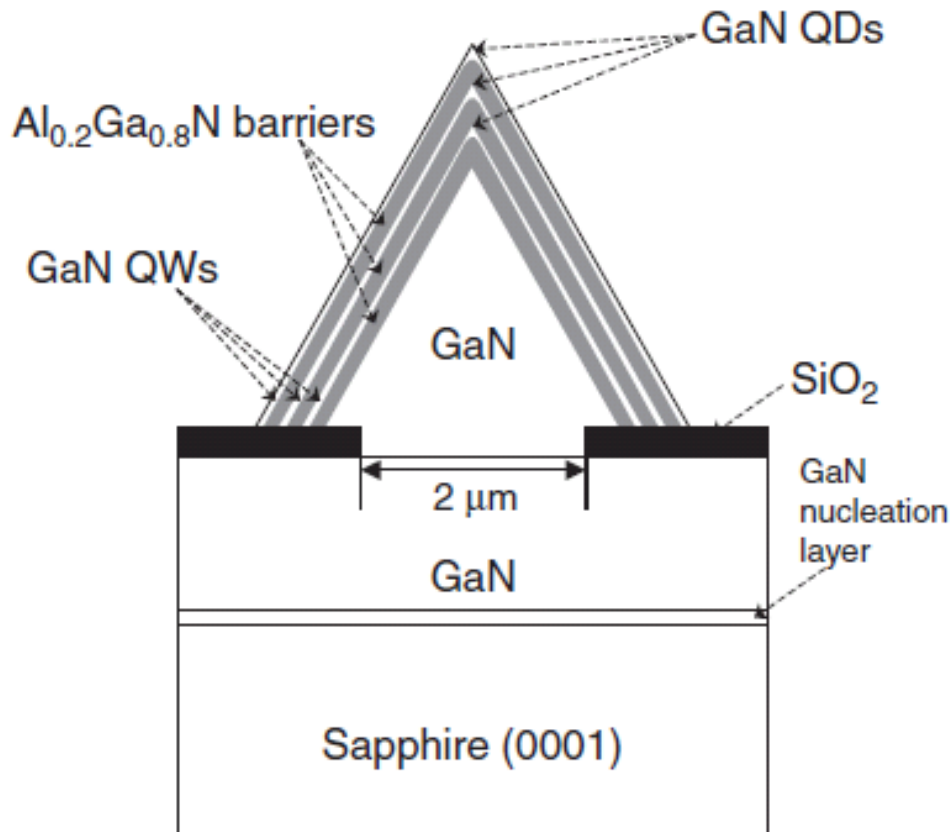
Isolated GaN pyramids

Li et al. APL, 73, 1179 (1998).

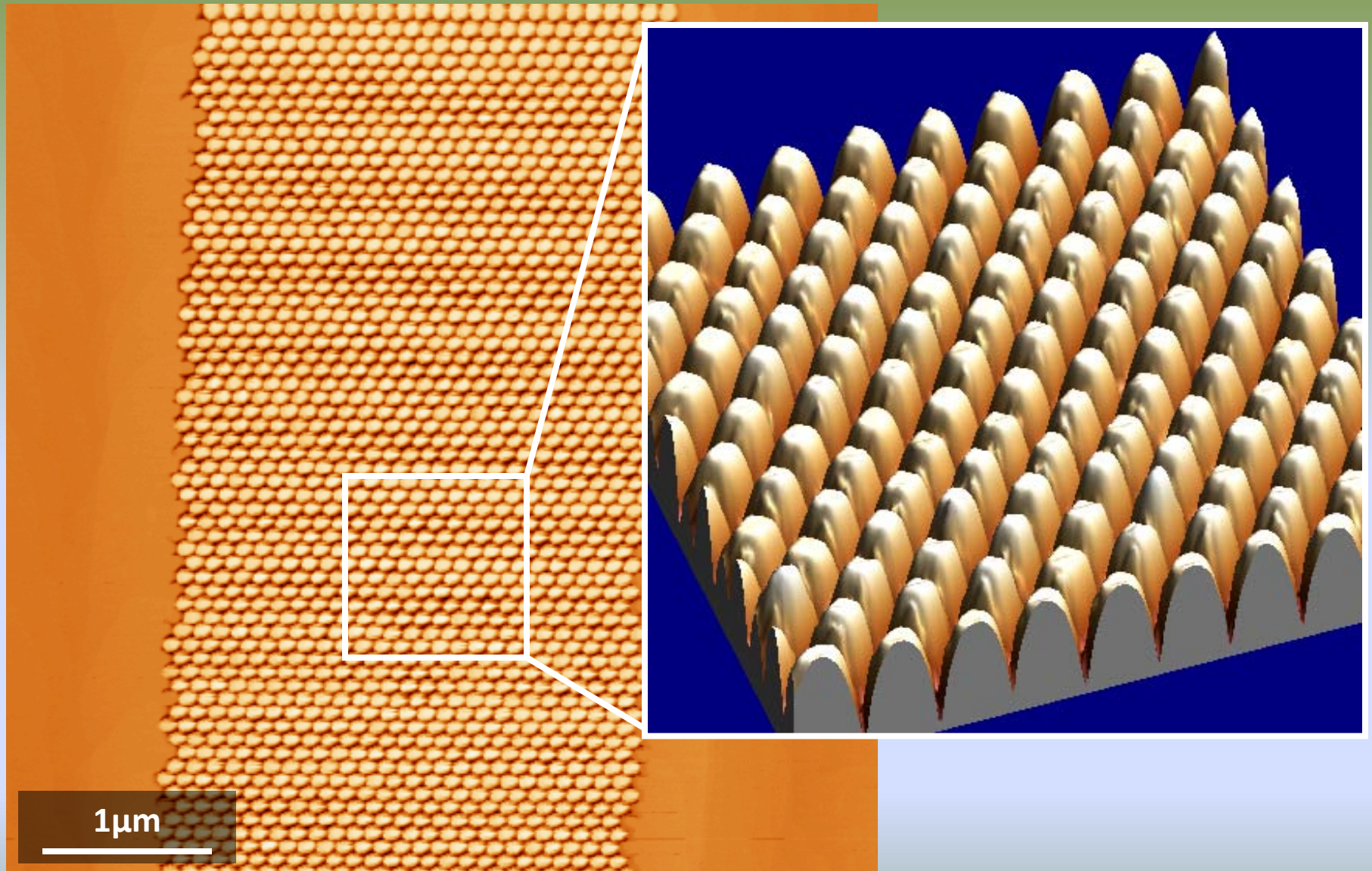


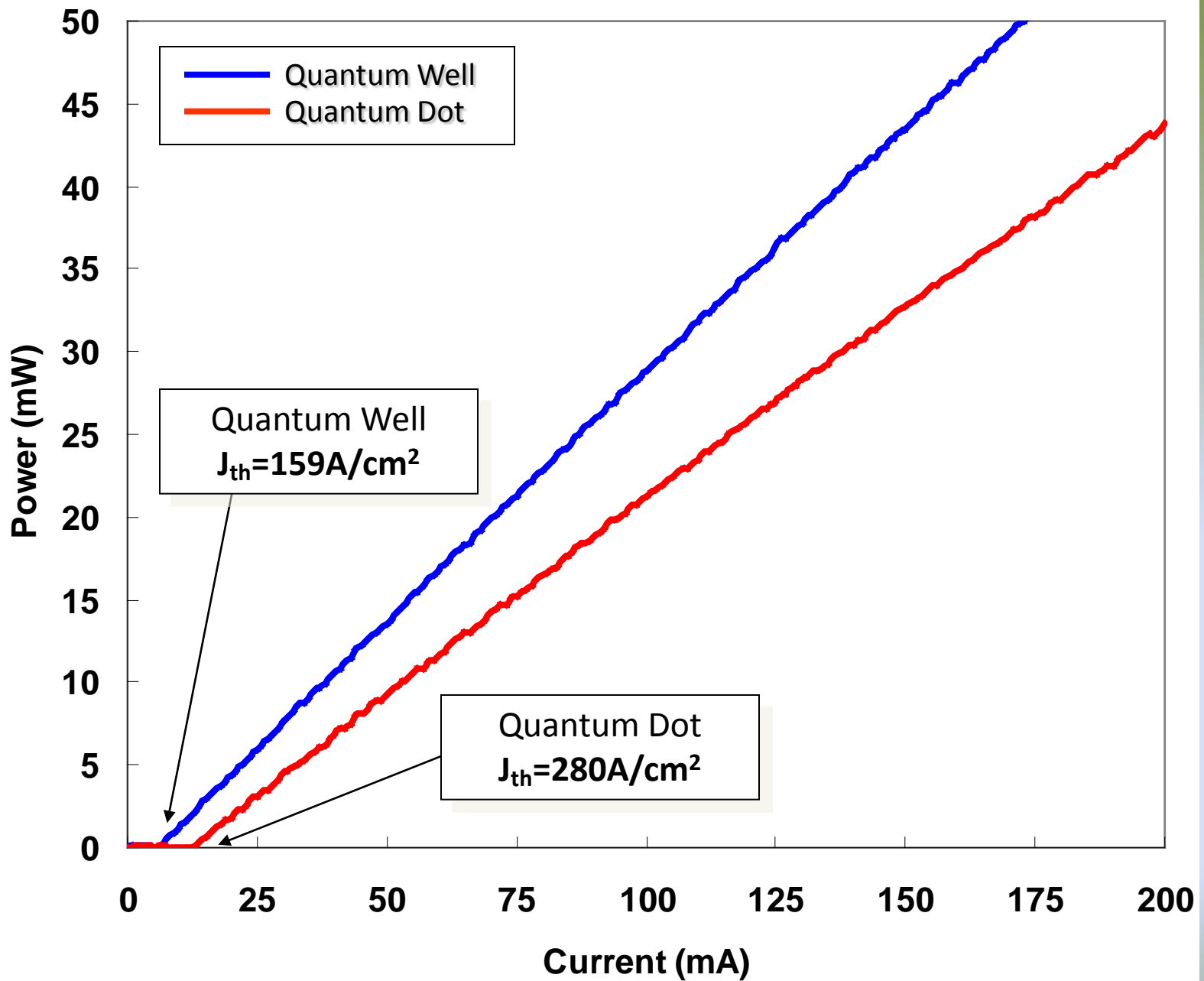
Partially coalesced

QDs at the Apex

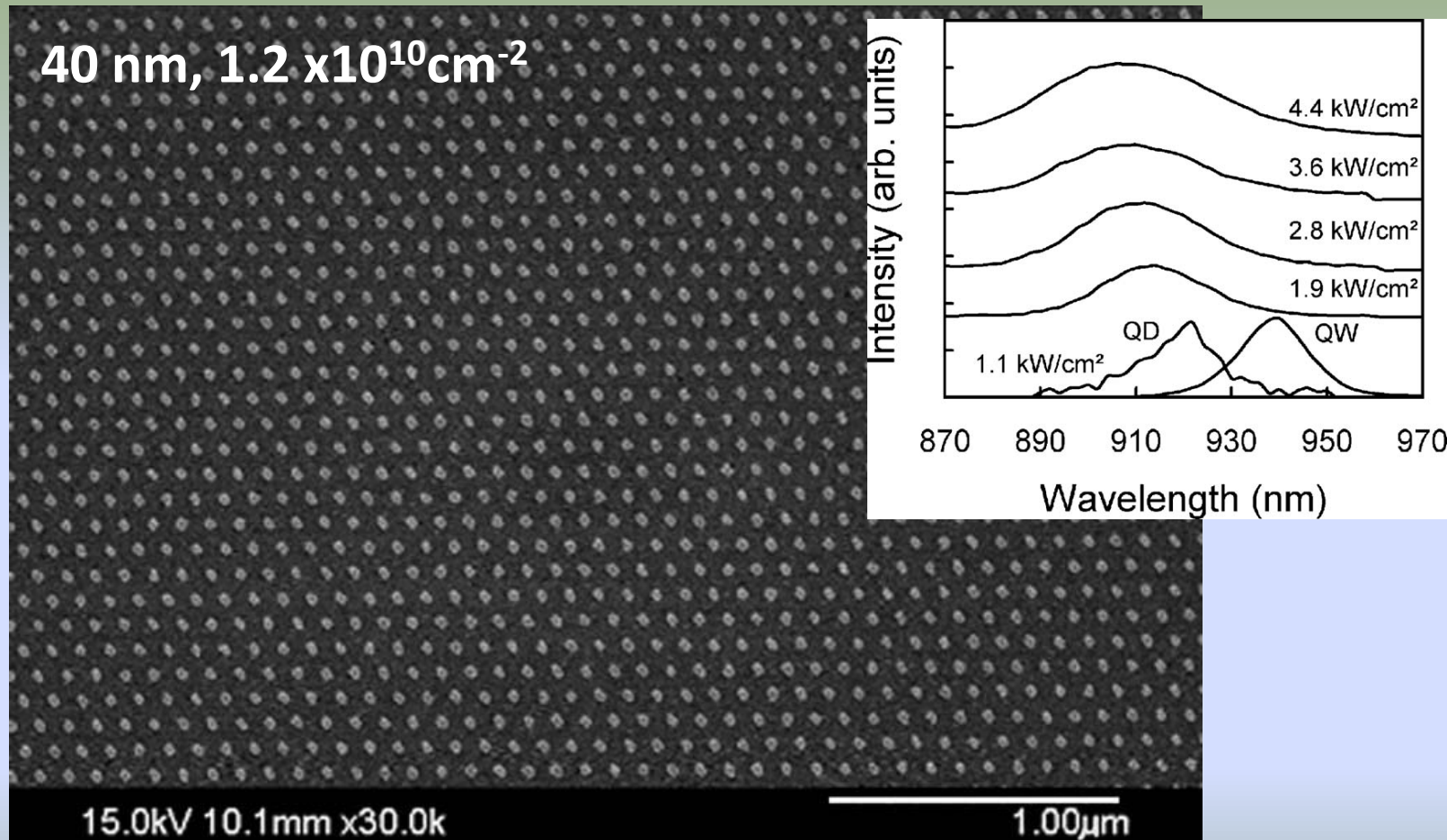


Oxide Patterned InGaAs QDs





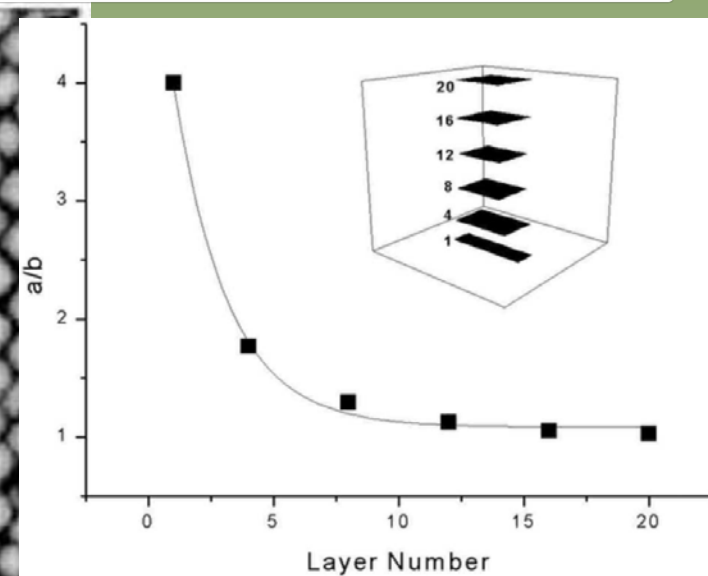
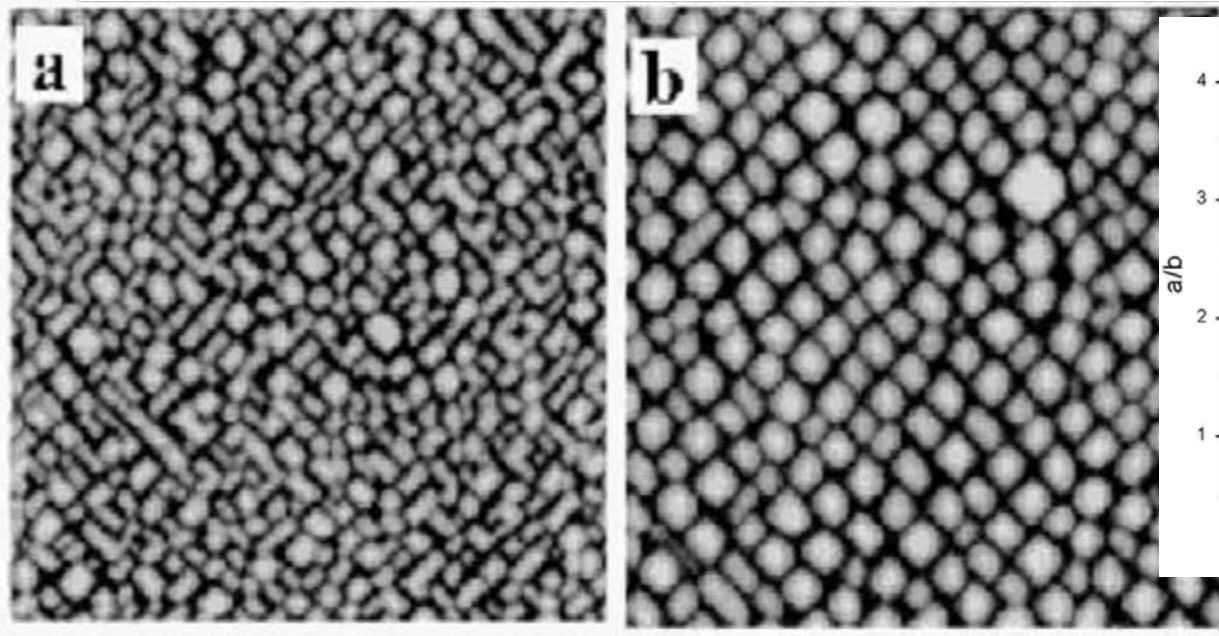
InGaAs QDs by top-down e-beam patterning and wet etching using HSQ as mask



Multilayer Ordering: vertical positioning

- 3D arrays of QDs
- Self-assembly through strain management
- Alternating: GaAs/QD/GaAs/QD/GaAs
- Spacer layer
- Lateral strain inhomogeneity due to buried islands is transmitted to the surface through strain, so that nucleation of 3D islands in the 2nd and subsequent layers is no longer spatially random.

Vertical Correlation: SiGe QDs on Si



- Spacer layer thickness dependence
- Islands become larger w layer #
- Islands become more regular in shape
- Increase in size $\propto 1/\text{density}$
- Wetting layer thickness decrease w layer #
- Solution: reduce Ge dose w layer #

InGaAs QDs on GaAs: 50 periods

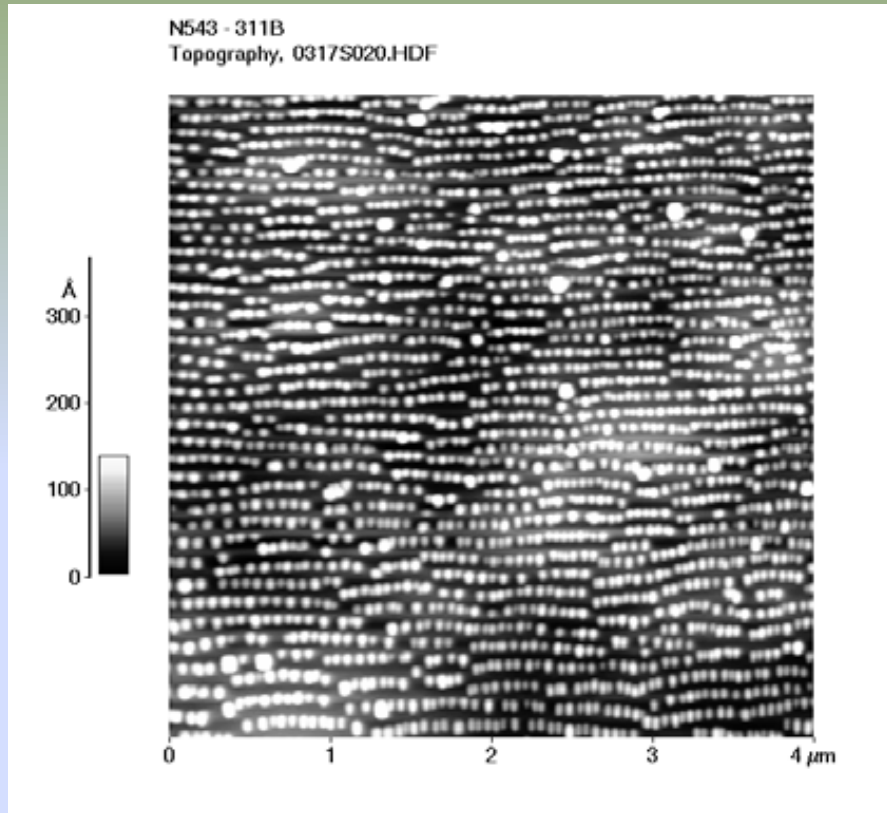


Fig. 4. AFM image of a 50-period undoped InGaAs (6.1 ML)/GaAs (20 nm) QD SL grown on {113}B GaAs substrate.

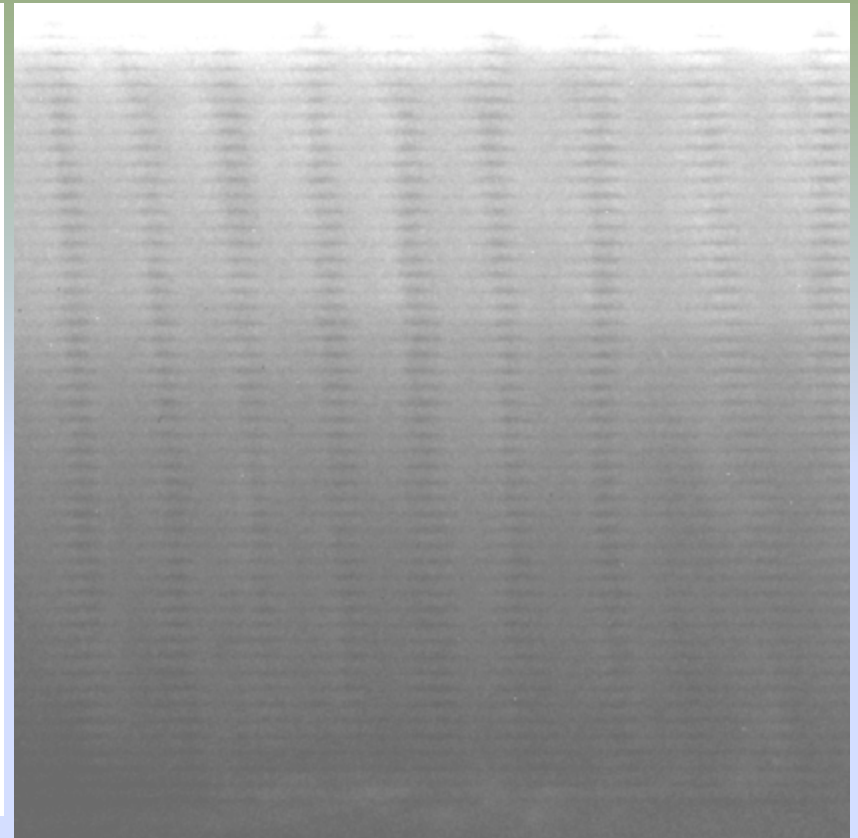
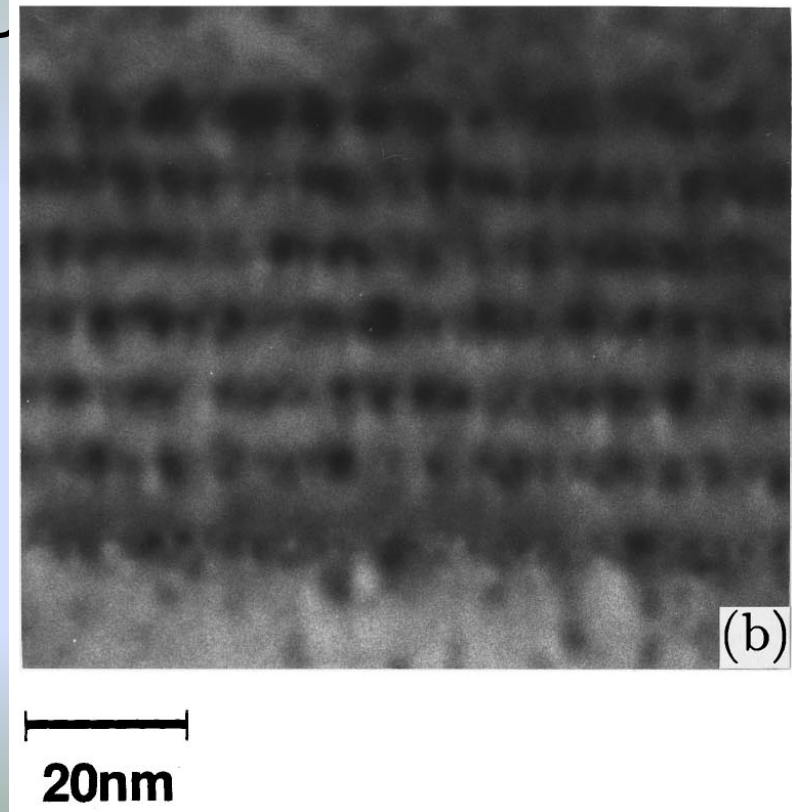
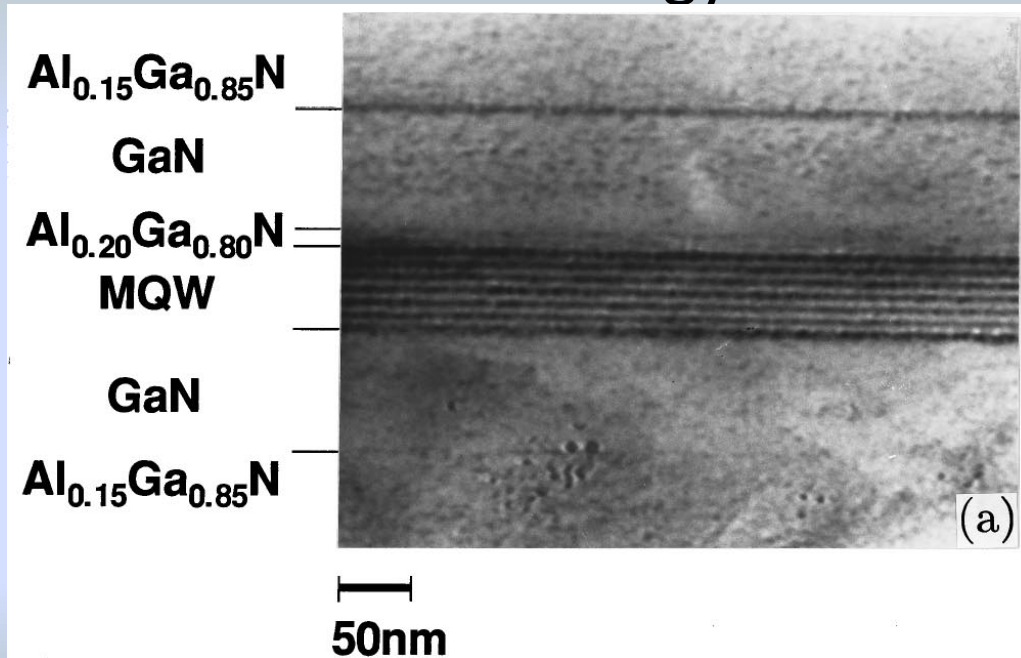


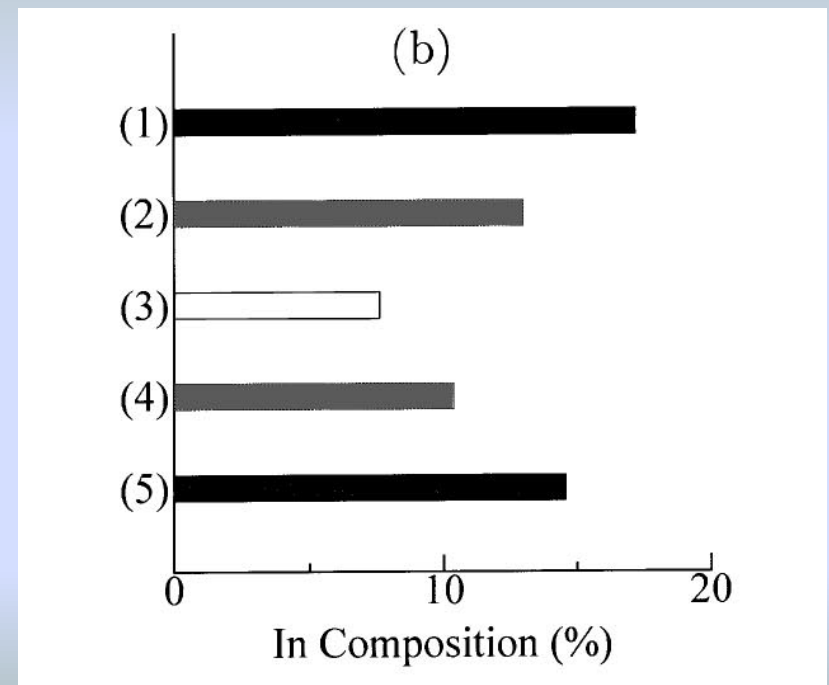
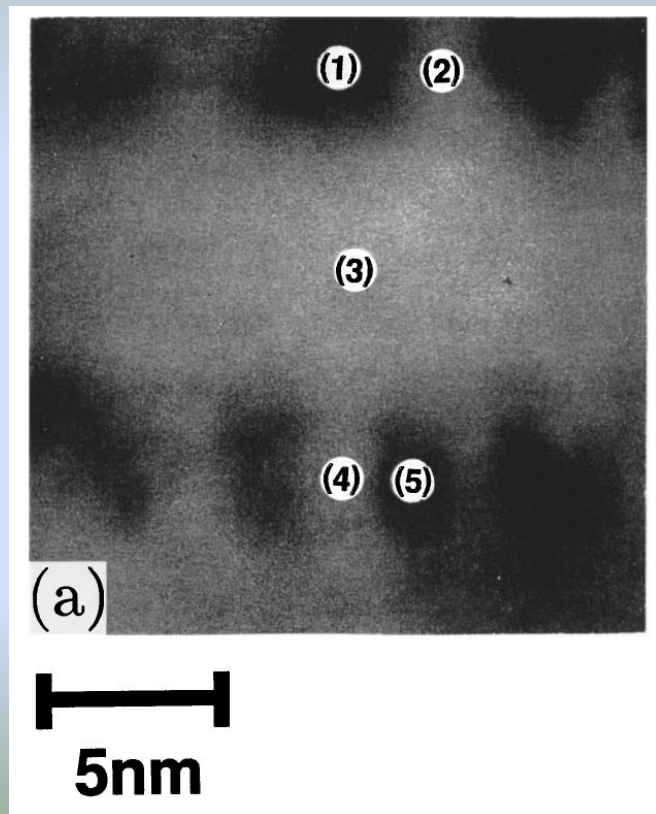
Fig. 5. <-110> pole bright-field TEM cross-section image of a 50-period undoped InGaAs (6.1 ML)/GaAs (20 nm) QD SL grown on {113}B GaAs substrate.

Composition Fluctuation in InGaN QW Blue LEDs

- Nominal quantum well structure:
 - $\text{In}_{0.2}\text{Ga}_{0.8}\text{N}$ 3nm well / $\text{In}_{0.05}\text{Ga}_{0.95}\text{N}$ 6 nm barrier
 - Localized energy states - QD

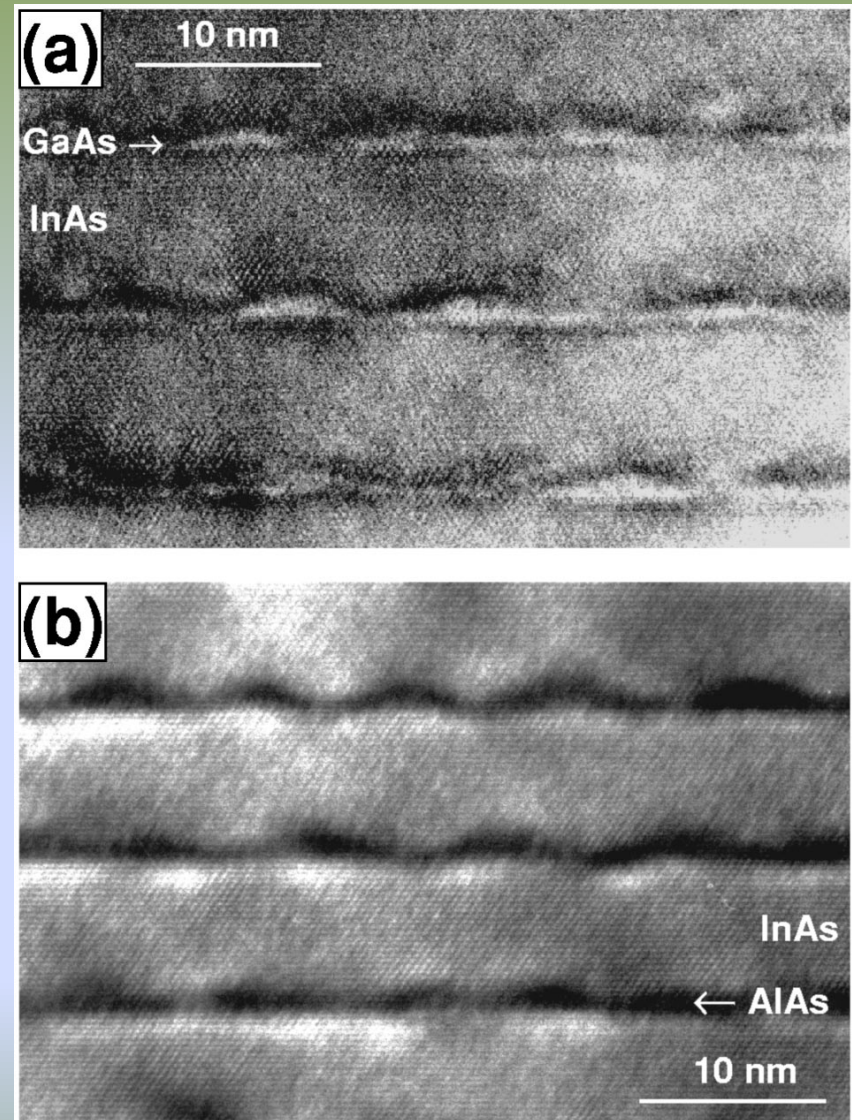


- Compositional modulation due to phase separation to produce In-rich QDs
- High quantum efficiency of the system despite $> 10^8 \text{ cm}^{-3}$ dislocation density is attributed to deep localization of excitons in QDs



Antidots: tensile strained QDs

- Only compressively strained materials readily form self-organized QDs
- Tensile strained QDs can only be formed under extreme non-equilibrium conditions
 - 0.06 (GaAs), 0.04 (AlAs) and 0.25 (InAs) ML/s
- Applications
 - Not fully confined e-/h⁺ states
 - Yes confined optical phonon (phonon dots)



Summary

- Bottom-up self-organized QD formation
 - Critical thickness
 - S-K growth mode and coherently strained QDs
 - Energy minimization: size, shape, distribution
- Top-down patterned QD formation
 - Lithography defined growth template
 - Non-planar structure
 - Selective Area Epitaxy (SAE) or SAG
- Multi-stack QDs
- Composition modulation
- Anti-dots or nanopores